



## Material Content Data Sheet



<b>Sales Product Name</b>		IPD50R280CE		<b>Issued</b>		1. August 2018		
<b>MA#</b>		MA001795196						
<b>Package</b>		PG-TO252-3-343		<b>Weight*</b>		313.56 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.825	1.54	1.54	15387	15387
leadframe	inorganic material	phosphorus	7723-14-0	0.041	0.01		131	
	non noble metal	iron	7439-89-6	0.137	0.04		438	
	non noble metal	copper	7440-50-8	137.105	43.75	43.80	437253	437822
	non noble metal	aluminium	7429-90-5	1.768	0.56	0.56	5637	5637
wire	non noble metal	aluminium	7429-90-5	1.768	0.56	0.56	5637	5637
encapsulation	organic material	carbon black	1333-86-4	1.289	0.41		4112	
	plastics	epoxy resin	-	24.498	7.81		78129	
	inorganic material	silicondioxide	60676-86-0	103.150	32.90	41.12	328965	411206
leadfinish	non noble metal	tin	7440-31-5	3.834	1.22	1.22	12226	12226
solder	non noble metal	tin	7440-31-5	0.078	0.02		247	
	noble metal	silver	7440-22-4	0.097	0.03		309	
	non noble metal	lead	7439-92-1	3.701	1.18	1.23	11803	12359
heatspreader	inorganic material	phosphorus	7723-14-0	0.010	0.00		32	
	non noble metal	iron	7439-89-6	0.033	0.01		105	
	non noble metal	copper	7440-50-8	32.995	10.52	10.53	105226	105363
*deviation	< 10%		Sum in total:			100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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